

IGBT

SGW20N60RUF

Short Circuit Rated IGBT

General Description

Fairchild's RUF series of Insulated Gate Bipolar Transistors (IGBTs) provide low conduction and switching losses as well as short circuit ruggedness. The RUF series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

- Short circuit rated 10 μ s @ $T_C = 100$ °C, $V_{GE} = 15V$
- High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.2 \text{ V } @ I_C = 20 \text{A}$
- High input impedance

Applications

AC & DC motor controls, general purpose inverters, robotics, and servo controls.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Description | | SGW20N60RUF | Units |
|---------------------|---|--------------------------|-------------|-------|
| V _{CES} | Collector-Emitter Voltage | | 600 | V |
| V _{GES} | Gate-Emitter Voltage | | ± 20 | V |
| | Collector Current | @ T _C = 25°C | 32 | Α |
| IC | Collector Current | @ T _C = 100°C | 20 | А |
| I _{CM (1)} | Pulsed Collector Current | | 60 | Α |
| | Short Circuit Withstand Time | @ T _C = 100°C | 10 | μs |
| T _{SC} | Maximum Power Dissipation | @ T _C = 25°C | 195 | W |
| | Maximum Power Dissipation | @ T _C = 100°C | 75 | W |
| TJ | Operating Junction Temperature | | -55 to +150 | °C |
| T _{stg} | Storage Temperature Range | | -55 to +150 | °C |
| TL | Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds | | 300 | °C |

Notes

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

| Symbol | Parameter | Тур. | Max. | Units |
|-----------------|---|------|------|-------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | | 0.64 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (PCB Mount) (2) | | 40 | °C/W |

Notes:

(2) Mounted on 1" squre PCB (FR4 or G-10 Material)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|--------------------------------------|--|--|------|------|-------|-------|
| Off Cha | racteristics | | | | | |
| BV _{CES} | Collector-Emitter Breakdown Voltage | $V_{GE} = 0V, I_{C} = 250uA$ | 600 | | | V |
| $\Delta B_{VCES}/$ ΔT_J | Temperature Coefficient of Breakdown Voltage | V _{GE} = 0V, I _C = 1mA | | 0.6 | | V/°C |
| I _{CES} | Collector Cut-Off Current | $V_{CE} = V_{CES}, V_{GE} = 0V$ | | | 250 | uA |
| I _{GES} | G-E Leakage Current | $V_{GE} = V_{GES}, V_{CE} = 0V$ | | | ± 100 | nA |
| On Char | racteristics | | | | | |
| V _{GE(th)} | G-E Threshold Voltage | $I_C = 20$ mA, $V_{CE} = V_{GE}$ | 5.0 | 6.0 | 8.5 | V |
| VGE(tn) | Collector to Emitter | $I_C = 20A$, $V_{GE} = 15V$ | | 2.2 | 2.8 | V |
| $V_{CE(sat)}$ | Saturation Voltage | $I_C = 32A$, $V_{GE} = 15V$ | | 2.5 | | V |
| D | , , | 10 02.15, 1GE 101 | | | | - |
| • | C Characteristics Input Capacitance | | | 1323 | | pF |
| C _{ies} | Output Capacitance | $V_{CE} = 30V_{V_{GE}} = 0V_{V_{GE}}$ | | 254 | | pF |
| C _{oes} C _{res} | Reverse Transfer Capacitance | f = 1MHz | | 47 | | pF |
| | ng Characteristics Turn-On Delay Time | | | 30 | | ns |
| t _{d(on)} | Turn-On Delay Time | | | 30 | | ns |
| t _r | Rise Time | | | 49 | | ns |
| t _{d(off)} | Turn-Off Delay Time | $V_{CC} = 300 \text{ V}, I_{C} = 20\text{A},$ | | 48 | 70 | ns |
| t _f | Fall Time | $R_G = 10\Omega, V_{GE} = 15V,$ | | 152 | 200 | ns |
| E _{on} | Turn-On Switching Loss | Inductive Load, T _C = 25°C | | 524 | | uJ |
| E _{off} | Turn-Off Switching Loss | | | 473 | | uJ |
| E _{ts} | Total Switching Loss | | | 997 | 1400 | uJ |
| t _{d(on)} | Turn-On Delay Time | | | 30 | | ns |
| t _r | Rise Time | | | 51 | | ns |
| t _{d(off)} | Turn-Off Delay Time | $V_{CC} = 300 \text{ V}, I_{C} = 20\text{A},$ | | 52 | 75 | ns |
| t _f | Fall Time | $R_G = 10\Omega, V_{GE} = 15V,$ | | 311 | 400 | ns |
| E _{on} | Turn-On Switching Loss | Inductive Load, T _C = 125°C | | 568 | | uJ |
| E _{off} | Turn-Off Switching Loss | 1 | | 1031 | | uJ |
| E _{ts} | Total Switching Loss | | | 1599 | 2240 | uJ |
| T _{sc} | Short Circuit Withstand Time | V _{CC} = 300 V, V _{GE} = 15V @ T _C = 100°C | 10 | | | us |
| Q _q | Total Gate Charge | | | 55 | 80 | nC |
| Q _{qe} | Gate-Emitter Charge | $V_{CE} = 300 \text{ V}, I_{C} = 20\text{A},$ | | 10 | 15 | nC |
| Q _{gc} | Gate-Collector Charge | V _{GE} = 15V | | 25 | 40 | nC |
| 90 | Internal Emitter Inductance | Measured 5mm from PKG | | 7.5 | | nH |

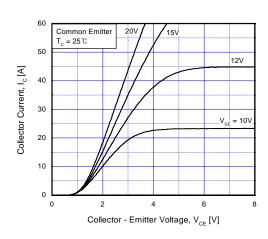


Fig 1. Typical Output Characteristics

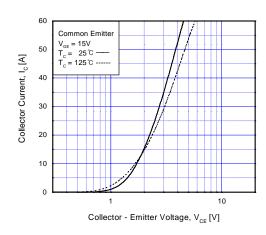


Fig 2. Typical Saturation Voltage Characteristics

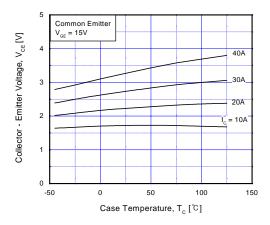


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

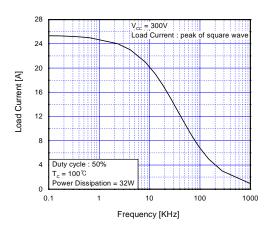


Fig 4. Load Current vs. Frequency

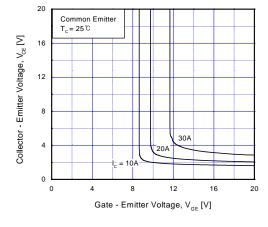


Fig 5. Saturation Voltage vs. V_{GE}

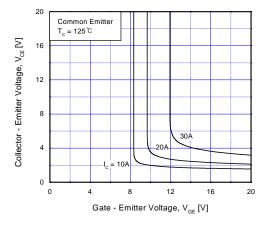
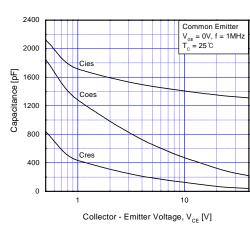


Fig 6. Saturation Voltage vs. V_{GE}

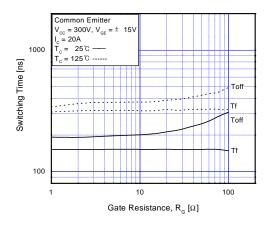
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Common Emitter $V_{cc} = 300V, V_{ce} = \pm 15V$ $I_c = 20A$ $T_c = 25^{\circ}C$ $T_c = 125^{\circ}C$ $T_r = 100$ $T_r = 100$

Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance



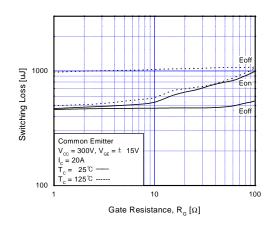
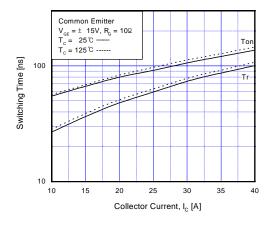


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



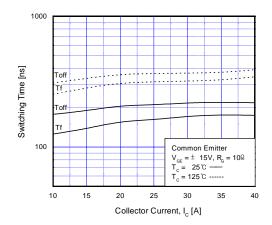
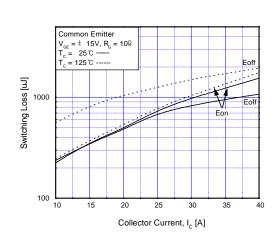


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current



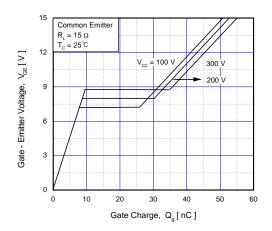
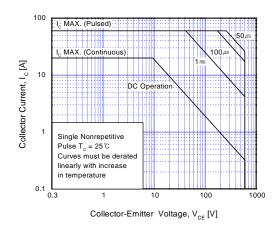


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



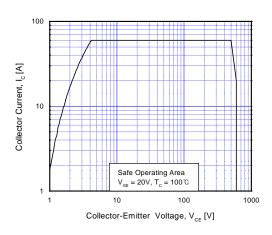


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

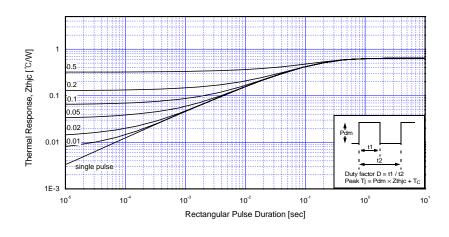
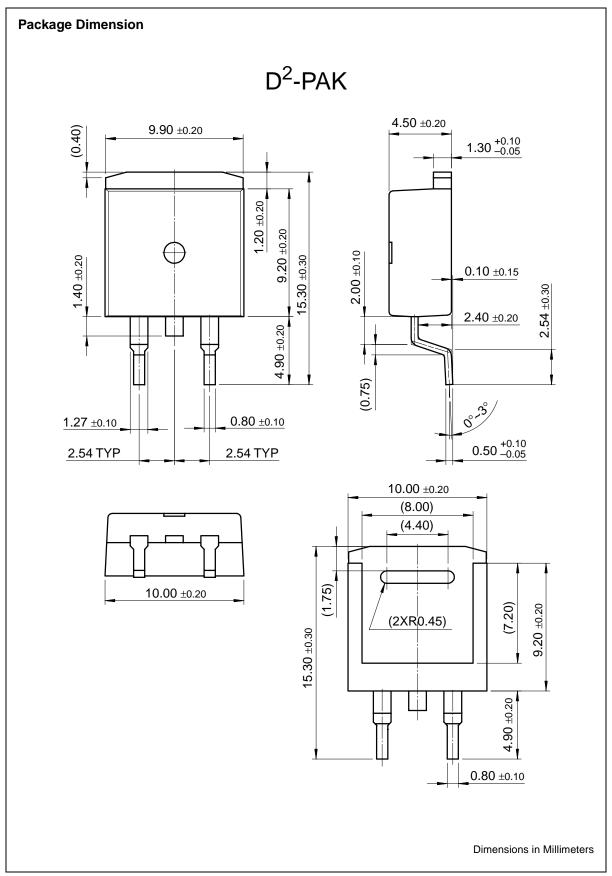


Fig 17. Transient Thermal Impedance of IGBT



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